



65V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
65V	4.4mΩ @ V _{GS} = 10V	81.7A
	6.3mΩ @ V _{GS} = 4.5V	68.2A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- High Frequency Switching
- Sync Rectification
- DC-DC Converters

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes Power Losses
- Low Q_a Minimizes Switching Losses
- Wettable Flank for Improved Optical Inspection
- Fast Switching Speed
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

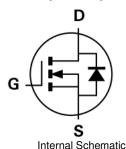
- Case: PowerDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish-Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



PowerDI5060-8 (SWP) (Type UX)

Top View

Bottom View



S Top View

Pin Configuration

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Ordering Information (Note 4)

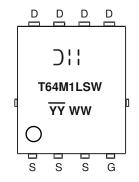
Part Number	Case	Packaging
DMT64M1LPSW-13	PowerDI5060-8 (SWP) (Type UX)	2500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

PowerDI5060-8 (SWP) (Type UX)



);; = Manufacturer's Marking T64M1LSW = Product Type Marking Code YYWW = Date Code Marking \overline{YY} = Year (ex: 20 = 2020) WW = Week (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	65	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Dusin Comment (Nata E)	T _A = +25°C		21.8	А
Continuous Drain Current (Note 5)	T _A = +70°C	ID	17.5	
Continuous Drain Current (Note 6)	Tc = +25°C	- I _D	81.7	- A
Continuous Drain Current (Note 6)	T _C = +70°C		65.3	
Maximum Continuous Body Diode Forward Current (Note 6)		Is	80	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		IDM	320	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		Ism	320	A
Avalanche Current, L=1mH		las	20.3	Α
Avalanche Energy, L=1mH		Eas	206	mJ
V_{DS} Spike $t = 10\mu s$		V _{SPIKE}	65	V

Thermal Characteristics

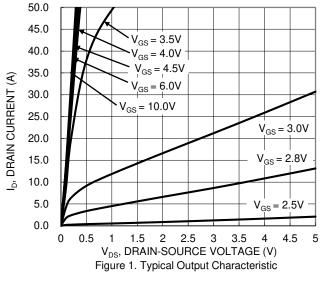
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) $T_A = +25^{\circ}C$		PD	3.14	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	39.8	°C/W	
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		P_{D}	44	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	2.84	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	65	_	_	V	$V_{GS} = 0V$, $I_D = 10mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 52V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)			•				
Gate Threshold Voltage	V _{GS(TH)}	1.3	1.7	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance			3.4	4.4	mΩ	VGS = 10V, ID = 30A	
Static Dialif-Source Oil-nesistance	RDS(ON)		4.9	6.3	11122	V _{GS} = 4.5V, I _D = 25A	
Diode Forward Voltage	V_{SD}		8.0	1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)			•				
Input Capacitance	Ciss		2626			V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		905	_	pF		
Reverse Transfer Capacitance	Crss		91	_		I = IIVIHZ	
Gate Resistance	R_g		1.21	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg		51.4	_			
Total Gate Charge (V _{GS} = 4.5V)	Qg		28.9	_	nC	\/ 20\/ In 20A	
Gate-Source Charge	Qgs		8.2	_	nC	$V_{DD} = 30V, I_D = 30A$	
Gate-Drain Charge	Qgd		14.4	_			
Turn-On Delay Time	td(ON)		11.5	_		V _{DD} = 30V, V _{GS} = 10V,	
Turn-On Rise Time	tr		7.8	_	20		
Turn-Off Delay Time	t _{D(OFF)}		35.1	_	ns	$I_D = 30A, R_G = 3.3\Omega$	
Turn-Off Fall Time	tF		19.9	_			
Body Diode Reverse Recovery Time	trr		44.8	_	ns	004 11/11 4004/	
Body Diode Reverse Recovery Charge	Qrr	_	54.0	_	$\frac{1}{1}$ IF = 30A, di/dt = 100A/µs		

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:





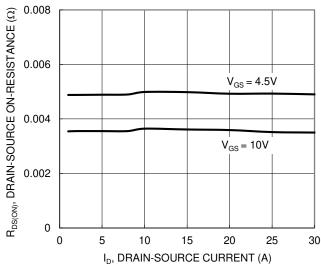


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

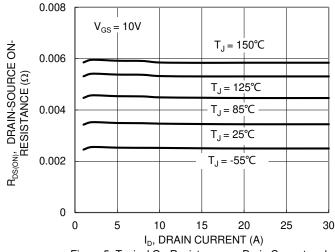
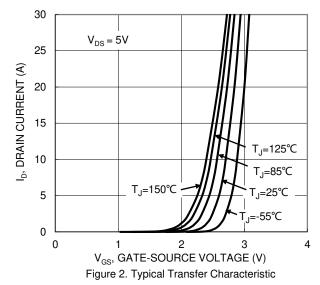
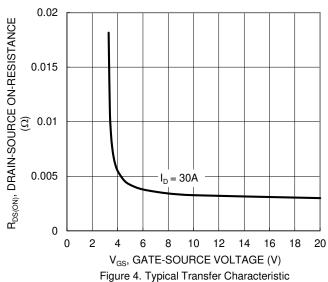
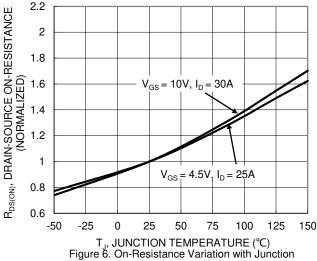


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

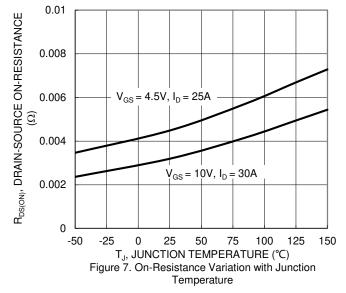


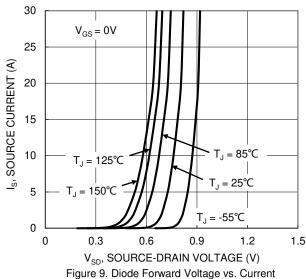


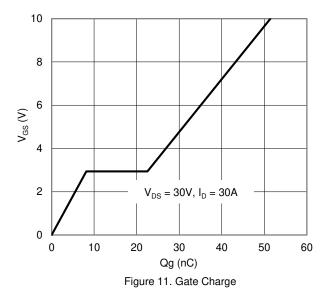












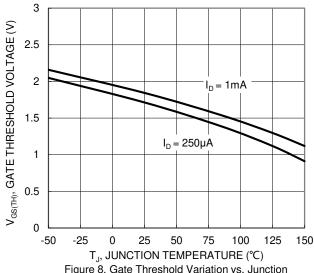
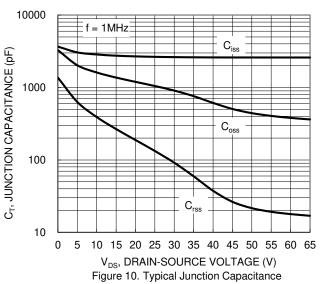


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R_{DS(ON)} Limited 100 ID, DRAIN CURRENT (A) $P_W = 10 \mu s$ 10 $P_W = 100 \mu s$ =10ms 1 =100ms $T_{J(Max)} = 150\,^{\circ}\mathrm{C}$ $T_{C} = 25\,^{\circ}\mathrm{C}$ $P_W = 1s$ 0.1 Single Pulse **DUT** on Infinite Heatsink $V_{GS} = 10V$ 0.01 0.1 10 100 V_{DS} , DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



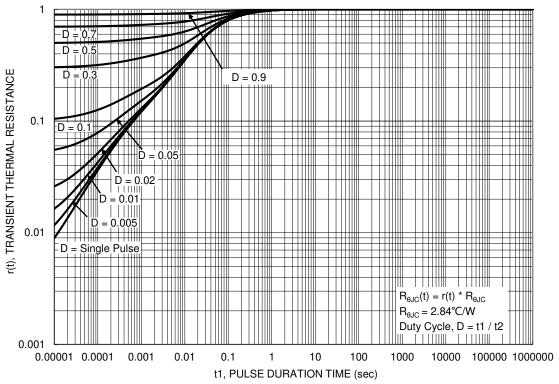


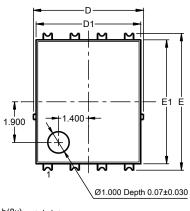
Figure 13. Transient Thermal Resistance

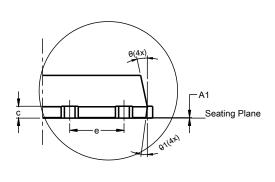


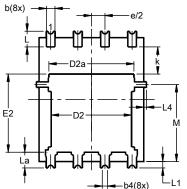
Package Outline Dimensions

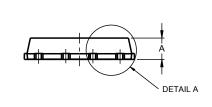
 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

PowerDI5060-8 (SWP) (Type UX)









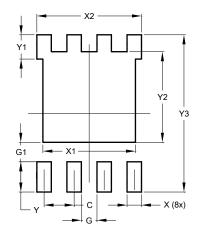
DETAIL A

PowerDI5060-8 (SWP)						
(Type UX)						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF				
С	0.230	0.330	0.277			
D		.15 BS0				
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	4.18	3.98			
Е	6	.40 BS0	3			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1.27BSC					
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L1a	0.050REF					
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
פווטופווסוטווס	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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